

STGW20NC60VD

30 A, 600 V, very fast IGBT

Features

- High current capability
- High frequency operation up to 50 KHz
- Very soft ultra fast recovery antiparallel diode

Description

This IGBT utilizes the advanced Power MESH™ process resulting in an excellent trade-off between switching performance and low on-state behavior.

Applications

- High frequency inverters, UPS
- Motor drive
- SMPS and PFC in both hard switch and resonant topologies

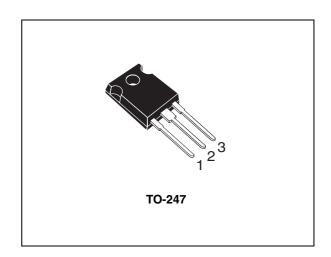


Figure 1. Internal schematic diagram

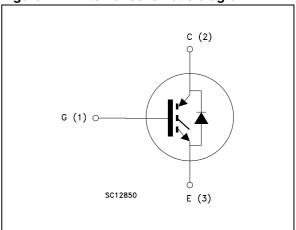


Table 1. Device summary

Order code	Marking Package		Packaging
STGW20NC60VD	GW20NC60VD	TO-247	Tube

Contents STGW20NC60VD

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STGW20NC60VD Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{CES}	Collector-emitter voltage (V _{GE} = 0)	600	٧
I _C ⁽¹⁾	Continuous collector current at Tc= 25°C	60	Α
I _C ⁽¹⁾	Continuous collector current at Tc= 100°C	30	Α
I _{CP} ⁽²⁾	Pulsed collector current	150	Α
I _{CL} ⁽³⁾	Turn-off latching current	100	Α
V _{GE}	Gate-emitter voltage	± 20	V
I _F	Diode RMS forward current at Tc=25°C	30	Α
I _{FSM}	Surge not repetitive forward current tp = 10 ms sinusoidal	120	Α
P _{TOT}	Total dissipation at T _C = 25°C	200	W
T _j	Operating junction temperature	- 55 to 150	°C
T _{stg}	Storage temperature	- 55 to 150	

^{1.} Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{j(max)} - T_{C}}{R_{thj-c} \times V_{CE(sat)(max)}(T_{j(max)}, I_{C}(T_{C}))}$$

- 2. Pulse width limited by maximum junction temperature and turn-off within RBSOA.
- 3. V_{clamp} = 80 % V_{CES} , T_J = 150 °C, R_G = 10 Ω , V_{GE} = 15 V.

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case IGBT	0.63	°C/W
' 'thj-case	Thermal resistance junction-case diode	1.5	°C/W
R _{thj-amb}	Thermal resistance junction-ambient	50	°C/W

Electrical characteristics STGW20NC60VD

2 Electrical characteristics

 $(T_j = 25^{\circ}C \text{ unless otherwise specified})$

Table 4. Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)CES}	Collector-emitter breakdown voltage (V _{GE} = 0)	I _C = 1 mA	600			V
V _{CE(sat)}	Collector-emitter saturation voltage	V _{GE} =15 V, I _C =20 A V _{GE} =15 V, I _C =20 A,T _j =125 °C		1.8 1.7	2.5	V V
V _{GE(th)}	Gate threshold voltage	$V_{CE} = V_{GE}$, $I_{C} = 250 \mu A$	3.75		5.75	٧
I _{CES}	Collector-cut-off current (V _{GE} = 0)	V _{CE} = 600 V V _{CE} =600 V, T _j = 125 °C			250 1	μA mA
I _{GES}	Gate-emitter leakage current (V _{CE} = 0)	V _{GE} = ± 20V			±100	nA
9 _{fs}	Forward transconductance	$V_{CE} = 15 \text{ V}, I_{C} = 20 \text{ A}$		15		S

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max	Unit
C _{ies} C _{oes} C _{res}	Input capacitance Output capacitance Reverse transfer capacitance	$V_{CE} = 25V$, $f = 1$ MHz, $V_{GE} = 0$	-	2200 225 50		pF pF pF
Q _g Q _{ge} Q _{gc}	Total gate charge Gate-emitter charge Gate-collector charge	V_{CE} = 390V, I_{C} = 20A, V_{GE} = 15V, (see Figure 18)	-	100 16 45	140	nC nC nC

Table 6. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r (di/dt) _{onf}	Turn-on delay time Current rise time Turn-on current slope	V_{CC} =390 V, I_{C} = 20 A, R_{G} =3.3 Ω , V_{GE} =15V (see Figure 17)	-	31 11 1600	-	ns ns A/µs
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	V_{CC} =390 V, I_{C} = 20 A, R_{G} =3.3 Ω V _{GE} =15 V T_{j} =125°C (see Figure 17)	-	31 11.5 1500	-	ns ns A/µs
t _{r(Voff)} t _{d(off)} t _f	Off voltage rise time Turn-off delay time Current fall time	V_{CC} =390 V, I_{C} = 20 A, R_{G} =3.3 Ω , V_{GE} =15 V (see Figure 17)	1	28 100 75	1	ns ns ns
t _{r(Voff)} t _{d(off)} t _f	Off voltage rise time Turn-off delay time Current fall time	V_{CC} =390 V, I_{C} = 20 A, R_{G} =3.3 Ω , V_{GE} =15 V T_{j} =125°C (see Figure 17)	-	66 150 130	-	ns ns ns

Table 7. Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
E _{on} ⁽¹⁾ E _{off} E _{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	V_{CC} =390 V, I_{C} = 20 A, R_{G} =3.3 Ω , V_{GE} =15 V, (see Figure 19)	-	220 330 550	300 450 750	μJ μJ μJ
E _{on} ⁽¹⁾ E _{off} E _{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	V_{CC} =390 V, I_{C} = 20 A, R_{G} =3.3 Ω V_{GE} =15 V, T_{J} = 125°C (see Figure 19)	-	450 770 1220		րվ րվ րվ

Eon is the turn-on losses when a typical diode is used in the test circuit in *Figure 19*. Eon include diode recovery energy. If the IGBT is offered in a package with a co-pak diode, the co-pack diode is used as external diode. IGBTs & Diode are at the same temperature (25°C and 125°C).

Electrical characteristics STGW20NC60VD

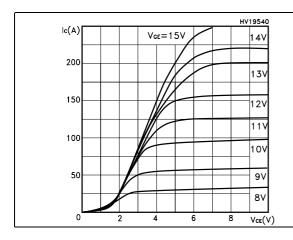
Table 8. Collector-emitter diode

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
V _F	Forward on-voltage	I _F = 20 A I _F = 20 A, T _j = 125°C	-	2 1.6	-	V V
t _{rr} Q _{rr} I _{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	I_F = 20 A, V_R = 40 V, T_j = 25°C, di/dt =100 A/µs (see Figure 20)	-	44 66 3	-	ns nC A
t _{rr} Q _{rr} I _{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_F = 2 \text{ 0A}, V_R = 40 \text{ V},$ $T_j = 125^{\circ}\text{C},$ $di/dt = 100 \text{ A/}\mu\text{s}$ (see Figure 20)	-	88 237 5.4	-	ns nC A

2.1 Electrical characteristics (curves)

Figure 2. Output characteristics

Figure 3. Transfer characteristics



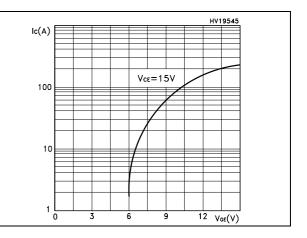
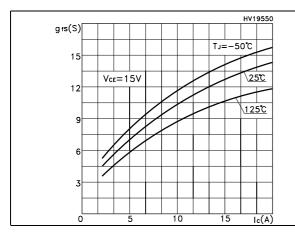


Figure 4. Transconductance

Figure 5. Collector-emitter on voltage vs temperature



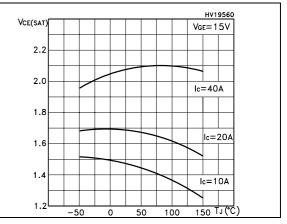
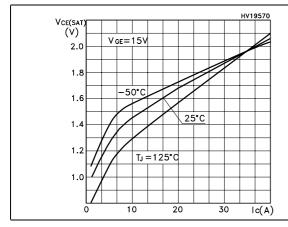
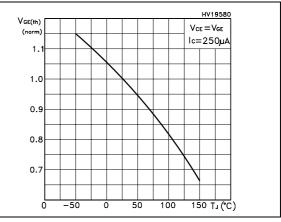


Figure 6. Collector-emitter on voltage vs collector current

Figure 7. Normalized gate threshold vs temperature





Electrical characteristics STGW20NC60VD

Figure 8. Normalized breakdown voltage vs Figure 9. Gate charge vs gate-emitter voltage temperature

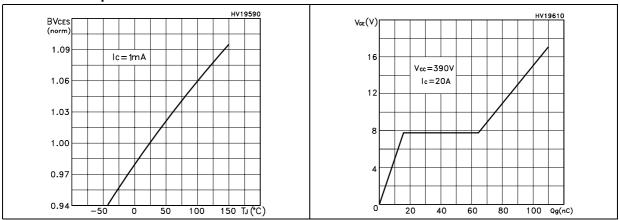


Figure 10. Capacitance variations

Figure 11. Switching losses vs temperature

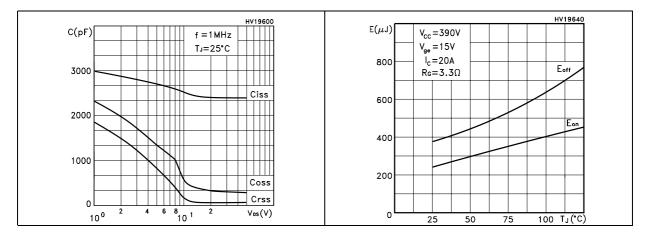


Figure 12. Switching losses vs gate resistance Figure 13. Switching losses vs collector current

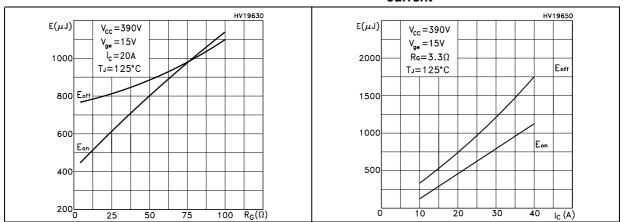


Figure 14. Thermal impedance

Figure 15. Turn-off SOA

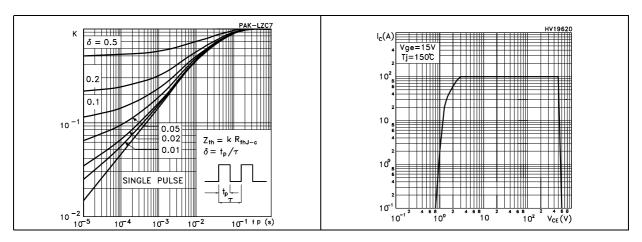
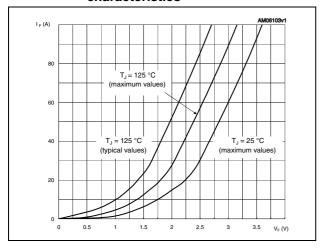


Figure 16. Emitter-collector diode characteristics



Test circuits STGW20NC60VD

3 Test circuits

Figure 17. Test circuit for inductive load switching

Figure 18. Gate charge test circuit

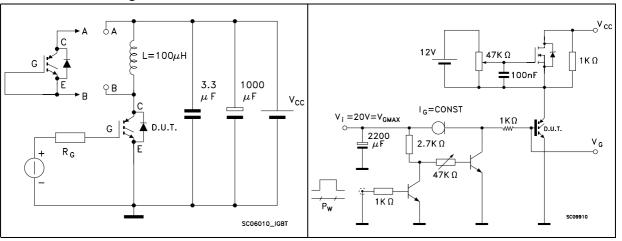
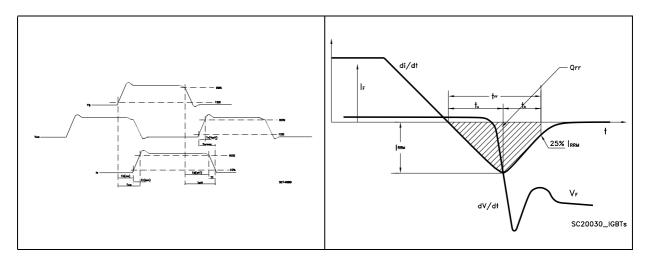


Figure 19. Switching waveforms

Figure 20. Diode recovery times waveform



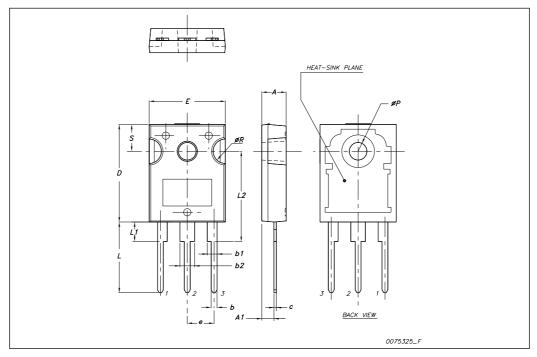
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4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

TO-247	mechan	nical	data

Dim		mm.	
Dim.	Min.	Тур.	Max.
A	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
С	0.40		0.80
D	19.85		20.15
E	15.45		15.75
е		5.45	
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
øΡ	3.55		3.65
øR	4.50		5.50
S		5.50	



STGW20NC60VD Revision history

5 Revision history

Table 9. Revision history

Date	Revision	Changes
12-Jul-2004	4	Stylesheet updated. Added switching losses maximum values in <i>Table 7: Switching energy (inductive load)</i> . Inserted <i>Figure 20: Diode recovery times waveform</i> .
09-Mar-2010	5	Inserted I _{FSM} parameter on <i>Table 2: Absolute maximum ratings</i> . Updated <i>Figure 16: Emitter-collector diode characteristics</i> and package mechanical data. Minor text changes to improve readability.

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